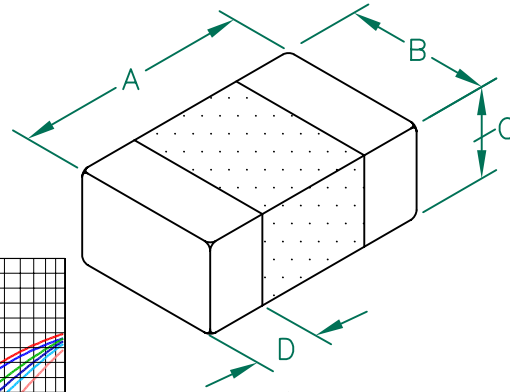


MI0805K110R-10

PHYSICAL DIMENSIONS:

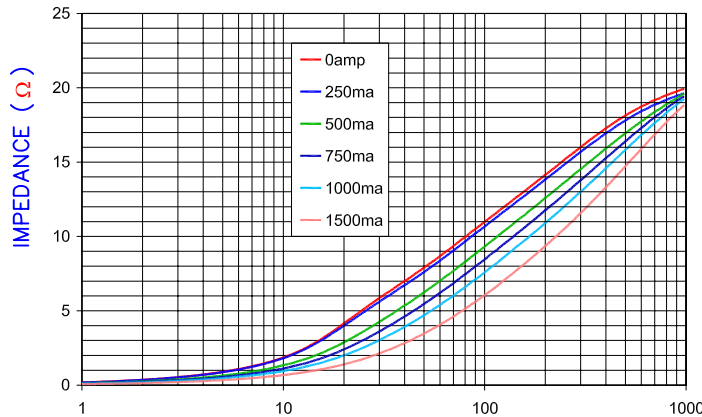
A	2.00 [.079]	+ 0.20 [.008]
B	1.25 [.049]	+ 0.20 [.008]
C	0.90 [.035]	+ 0.20 [.008]
D	0.51 [.020]	+ 0.25 [.010]



ELECTRICAL CHARACTERISTICS:

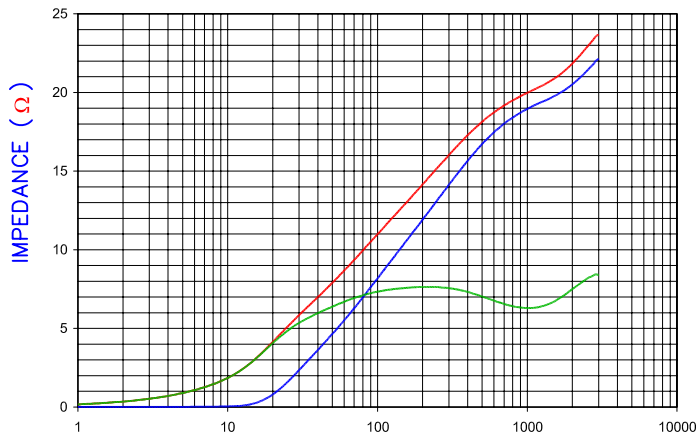
Z @ 100MHz (Ω)	DCR (Ω)	Rated Current
Nominal	11	
Minimum	8	
Maximum	14	1500 mA

Z vs FREQUENCY
IMPEDANCE UNDER DC BIAS



FREQUENCY (MHz)

|Z|, R, AND X vs. FREQUENCY

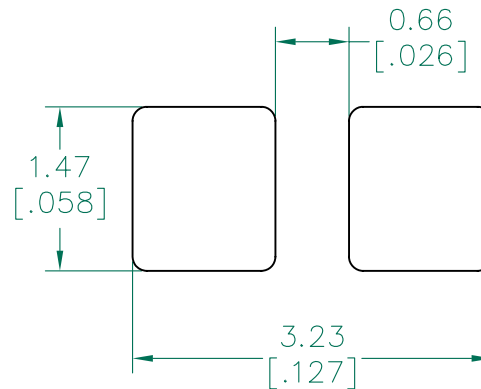


FREQUENCY (MHz)



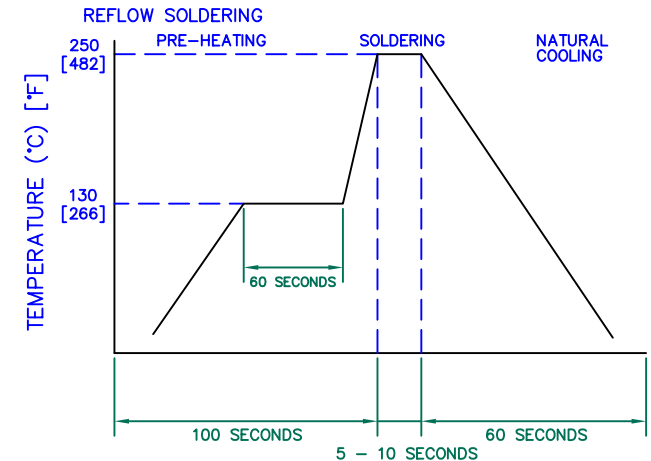
- NOTES: UNLESS OTHERWISE SPECIFIED
- TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 4000 PCS/REEL, PAPER TAPE.
 - TERMINATION FINISH IS 100% TIN.
 - COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 [.030] to this dimension)

RECOMMENDED SOLDERING CONDITIONS



DIMENSIONS ARE IN mm [INCHES].

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REV	DESCRIPTION	DATE	INT	PROJECT/PART NUMBER:	REV	PART TYPE:	DRAWN BY:
D	CHANGE TO PAPER TAPE	03/04/10	JUN	MI0805K110R-10	D	CO-FIRE	TMB
C	UPDATE COMPANY LOGO	08/06/08	JRK				
B	ADD ROHS & UPDATE COMPANY LOGO	08/28/07	JRK				
A	ORIGINAL DRAFT	04/05/04	TMB				
REV	DESCRIPTION	DATE	INT				
				DATE:	04/05/04	SCALE:	-
				GAD #	MI0805K110R-10-D	TOOL #	-
						SHEET:	2 of 2